

# Fengwei Wang

## List of Publications by Year in descending order

Source: <https://exaly.com/author-pdf/4660053/publications.pdf>

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5  
papers

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citations

2258059

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h-index

2272923

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g-index

5  
all docs

5  
docs citations

5  
times ranked

5  
citing authors

#	ARTICLE	IF	CITATIONS
1	Embedded thin film resistors fabricated by alkaline electroless deposition. Journal of Materials Science: Materials in Electronics, 2015, 26, 9766-9775.	2.2	5
2	Influences of copper roughness on the electrical and mechanical performances of embedded capacitance materials. Journal of Adhesion Science and Technology, 2016, 30, 1364-1369.	2.6	4
3	Influences of filler dispersity in epoxy resin on the electrical and mechanical performances of embedded capacitance materials. Journal of Materials Science: Materials in Electronics, 2018, 29, 17939-17947.	2.2	3
4	Improving the film-forming ability of BaTiO <sub>3</sub> /epoxy resin suspension by adjusting the solvent composition for the fabrication of embedded capacitance materials. Journal of Materials Science: Materials in Electronics, 2019, 30, 7743-7751.	2.2	2
5	Improving the electrical and mechanical performances of embedded capacitance materials by introducing tungsten disulfide nanoflakes into the dielectric layer. Journal of Materials Science: Materials in Electronics, 2020, 31, 7889-7897.	2.2	2